

MF5101

ADVANCES IN MANUFACTURING TECHNOLOGY

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OBJECTIVE:

- The students are expected to understand special machining processes, unconventional machining processes, micro machining process, nano fabrication processes and rapid prototyping.

UNIT I UNCONVENTIONAL MACHINING

10

Introduction-Bulk processes - surface processes- Plasma Arc Machining- Laser Beam Machining- Electron Beam Machining-Electrical Discharge Machining – Electro chemical Machining-Ultrasonic Machining- Water Jet Machining-Electro Gel Machining-Anisotropic machining-Isotropic machining- Elastic Emission machining – Ion Beam Machining.

UNIT II PRECISION MACHINING:

10

Ultra Precision turning and grinding: Chemical Mechanical Polishing (CMP) - ELID process – Partial ductile mode grinding-Ultra precision grinding- Binderless wheel – Free form optics. aspherical surface generation Grinding wheel- Design and selection of grinding wheel-High-speed grinding- High-speed milling- Diamond turning.

UNIT III ADVANCES IN METAL FORMING

7

Orbital forging, Isothermal forging, Warm forging, Overview of Powder Metal techniques –Hot and Cold isostatic pressing - high speed extrusion, rubber pad forming, Hydroforming, Superplastic forming, Peen forming-micro blanking –Powder rolling – Tooling and process parameters.

UNIT IV MICRO MACHINING AND NANO FABRICATION

10

Theory of micromachining-Chip formation-size effect in micromachining-microturning, micromilling, microdrilling- Micromachining tool design-Micro EDM-Microwire EDM-Nano fabrication:LIGA, Ion beam etching, Molecular manufacturing techniques –Atomic machining- Nano machining techniques – Top/Bottom up Nano fabrication techniques - Sub micron lithographic technique, conventional film growth technique, Chemical etching, Quantum dot fabrication techniques – MOCVD – Epitaxy techniques.

UNIT V RAPID PROTOTYPING AND SURFACE MODIFICATION TECHNIQUES

8

Introduction – Classification – Principle advantages limitations and applications- Stereo lithography – Selective laser sintering –FDM, SGC, LOM, 3D Printing-Surface modification Techniques: Sputtering-CVD-PVD-Diamond like carbon coating-Plasma Spraying Technique.-Diffusion coatings-Pulsed layer deposition.

TOTAL: 45 PERIODS

OUTCOMES:

At the end of this course the students are expected

1. to produce useful research output in machining of various materials
2. use this knowledge to develop hybrid machining techniques
3. Application of this knowledge to manage shop floor problems

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T.N.Palayam, Gobi (Tk),
Erode (Dt) - 638 506.

OBJECTIVES:

This course will enable the Student

- To gain knowledge about the basic fundamental of CAD.
- To gain knowledge on how computers are integrated at various levels of planning and manufacturing understand computer aided planning and control and computer monitoring.

UNIT I COMPUTER AIDED DESIGN 9

Concept of CAD as drafting and designing facility, desirable features of CAD package, drawing features in CAD – Scaling, rotation, translation, editing, dimensioning, labeling, Zoom, pan, redraw and regenerate, typical CAD command structure, wire frame modeling, surface modeling and solid modeling (concepts only) in relation to popular CAD packages.

UNIT II COMPONENTS OF CIM 9

CIM as a concept and a technology, CASA/Sme model of CIM, CIM II, benefits of CIM, communication matrix in CIM, fundamentals of computer communication in CIM – CIM data transmission methods – serial, parallel, asynchronous, synchronous, modulation, demodulation, simplex and duplex. Types of communication in CIM – point to point (PTP), star and multiplexing. Computer networking in CIM – the seven layer OSI model, LAN model, MAP model, network topologies – star, ring and bus, advantages of networks in CIM

UNIT III GROUP TECHNOLOGY AND COMPUTER AIDED PROCESS PLANNING 9

History Of Group Technology – role of G.T in CAD/CAM Integration – part families- classification and coding – DCLASS and MCLASS and OPTIZ coding systems – facility design using G.T – benefits of G.T – cellular manufacturing. Process planning - role of process planning in CAD/CAM

UNIT IV SHOP FLOOR CONTROL AND INTRODUCTION TO FMS 9

Shop floor control – phases – factory data collection system – automatic identification methods – Bar code technology – automated data collection system.
FMS – components of FMS – types – FMS workstation – material handling and storage system – FMS layout- computer control systems – applications and benefits.

UNIT V COMPUTER AIDED PLANNING AND CONTROL AND COMPUTER MONITORING 9

Production planning and control – cost planning and control – inventory management – material requirements planning (MRP) – shop floor control. Lean and Agile Manufacturing. Types of production monitoring systems – structure model of manufacturing – process control and strategies – direct digital control.

OUTCOMES:

At the end of this course the students are expected

1. to produce useful research output in computer integrated manufacturing
2. use this knowledge to develop computer techniques
3. Application of this knowledge to functionalise computer aided planning.

TOTAL: 45 PERIODS**REFERENCES:**

1. Chris McMahon and Jimmie Browne, "CAD CAM Principles, Practice and Manufacturing Management", Pearson Education second edition, 2005. Ranky, Paul G., "Computer Integrated Manufacturing", Prentice hall of India Pvt. Ltd., 2005.
2. James A. Regh and Henry W. Kreabber, "Computer Integrated Manufacturing", Pearson Education second edition, 2005.
3. Mikell. P. Groover "Automation, Production Systems and Computer Integrated Manufacturing", Pearson Education 2001.


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CM5251

ADVANCES IN METROLOGY AND INSPECTION

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OBJECTIVES:

- To teach the students basic concepts in various methods of engineering measurement techniques and applications, understand the importance of measurement and inspection in manufacturing industries.
- To make the students capable of learning to operate and use advanced metrological devices with ease in industrial environments.

UNIT I CONCEPTS OF METROLOGY:

8

Terminologies – Standards of measurement – Errors in measurement – Interchangeability and Selective assembly – Accuracy and Precision – Calibration of instruments – Basics of Dimensional metrology and Form metrology

UNIT II MEASUREMENT OF SURFACE ROUGHNESS:

9

Definitions – Types of Surface Texture: Surface Roughness Measurement Methods- Comparison, Contact and Non Contact type roughness measuring devices, 3D Surface Roughness Measurement, Nano Level Surface Roughness Measurement – Instruments.

UNIT III INTERFEROMETRY:

8

Introduction, Principles of light interference – Interferometers – Measurement and Calibration – Laser Interferometry.

UNIT IV MEASURING MACHINES AND LASER METROLOGY:

10

Tool Makers Microscope – Microhite – Coordinate Measuring Machines – Applications – Laser Micrometer, Laser Scanning gauge, Computer Aided Inspection techniques - In-process inspection, Machine Vision system-Applications.

UNIT V IMAGE PROCESSING FOR METROLOGY:

10

Overview, Computer imaging systems, Image Analysis, Preprocessing, Human vision system, Image model, Image enhancement, gray scale models, histogram models, Image Transforms - Examples.

TOTAL: 45 PERIODS


OUTCOMES:

At the end of this course the students are expected to

1. Understand the advanced measurement principles with ease.
2. Operate sophisticated measurement and inspection facilities.
3. Design and develop new measuring methods.

REFERENCES

1. "ASTE Handbook of Industries Metrology", Prentice Hall of India Ltd., 1992.
2. Bewoor, A.K. and Kulkarni, V.A., "Metrology and Measurement", Tata Mc Graw-Hill, 2009.
3. Galyer, F.W. and Shotbolt, C.R., "Metrology for engineers", ELBS, 1990.
4. Gupta, I.C., "A Text Book of engineering metrology", Dhanpat Rai and Sons, 1996.
5. Jain, R.K., "Engineering Metrology", Khanna Publishers, 2008.
6. Rajput, R.K., "Engineering Metrology and Instrumentations", Kataria & Sons Publishers, 2001.


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OBJECTIVE:

This course aims to impart knowledge on various techniques of material characterization.

UNIT I MICRO AND CRYSTAL STRUCTURE ANALYSIS 10
Principles of Optical Microscopy – Specimen Preparation Techniques – Polishing and Etching – Polarization Techniques – Quantitative Metallography – Estimation of grain size – ASTM grain size numbers – Microstructure of Engineering Materials - Elements of Crystallography – X- ray Diffraction – Bragg's law – Techniques of X-ray Crystallography – Debye – Scherer camera – Geiger Diffractometer – analysis of Diffraction patterns – Inter planer spacing – Identification of Crystal Structure, Elements of Electron Diffraction.

UNIT II ELECTRON MICROSCOPY 9
Interaction of Electron Beam with Materials – Transmission Electron Microscopy – Specimen Preparation – Imaging Techniques – BF & DF – SAD – Electron Probe Microanalysis – Scanning Electron Microscopy – Construction & working of SEM – various Imaging Techniques – Applications- Atomic Force Microscopy- Construction & working of AFM - Applications .

UNIT III CHEMICAL AND THERMAL ANALYSIS 9
Basic Principles, Practice and Applications of X-Ray Spectrometry, Wave Dispersive X-Ray Spectrometry, Auger Spectroscopy, Secondary Ion Mass Spectroscopy, Fourier Transform Infra Red Spectroscopy (FTIR)- Proton Induced X-Ray Emission Spectroscopy, Differential Thermal Analysis, Differential Scanning Calorimetry (DSC) And Thermo Gravimetric Analysis (TGA)

UNIT IV MECHANICAL TESTING – STATIC TESTS 8
Hardness – Brinell, Vickers, Rockwell and Micro Hardness Test – Tensile Test – Stress – Strain plot – Proof Stress – Torsion Test - Ductility Measurement – Impact Test – Charpy & Izod – DWTT - Fracture Toughness Test, Codes and standards for testing metallic and composite materials.

UNIT V MECHANICAL TESTING – DYNAMIC TESTS 9
Fatigue – Low & High Cycle Fatigues – Rotating Beam & Plate Bending HCF tests – S-N curve – LCF tests – Crack Growth studies – Creep Tests – LM parameters – AE Tests-modal analysis - Applications of Dynamic Tests.

TOTAL: 45 PERIODS

OUTCOMES:

At the end of this course the students are expected to be knowledgeable in microstructure evaluation, crystal structure analysis, electron microscopy, Chemical Thermal Analysis, static and dynamic mechanical testing methods.

REFERENCES:

1. ASM Hand book-Materials characterization, Vol – 10, 2004.
2. Cullity B.D., Stock S.R& Stock S., Elements of X ray Diffraction, (3rd Edition). Prentice Hall, 2001.
3. Davis J. R., Tensile Testing, 2nd Edition, ASM International, 2004.
4. Davis, H.E., Hauck G. & Troxell G.E., The Testing of engineering Materials, (4th Edition), McGraw Hill, College Divn., 1982.



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